Ultraform® N2320 0035

Acetal (POM) Copolymer BASF Corporation

Product Description

Rapidly solidifying standard grade for injection molding. Abbreviated designation according to ISO 1043: POM Designation according to ISO 9988-1: POM-K, M-GNR, 03-002

Ultraform® is supplied in the form of granules having a bulk density of approx. 850 g/l. Standards packs are the 25 kg PE bag and the 1000 kg Oktabin (octagonal container). Ultraform® is not subject to change when it is stored in dry, ventilated rooms. After relatively long storage (>1 year) or when handling material from previously opened containers, preliminary drying is recommended in order to remove any moisture which has been absorbed

Ultraform® is not a hazardous material as defined in the German Ordinance on Hazardous Materials. If Ultraform® is processed properly little or no formaldehyde occurs in the region of the processing machine. Measures should be taken to ensure ventilation and venting of the work area, preferably by means of an extraction hood over the barrel unit.

Ultraform® decomposes when subjected to excessive heat. The decomposition products formed in this case consist almost exclusively of formaldehyde, a gas which has a pungent smell even at very low concentrations and irritates the mucous membranes. Decomposition can rapidly result in the build-up of a high gas pressure in the barrel of the processing unit. If the die is sealed there may be a sudden release of pressure via the filling hopper. Contamination of Ultraform® by thermoplastics that cause ecomposition of polyacetals, e.g. PVC or plastics containing halogenated fire protection agents, must be avoided under all circumstances. Even small quantities can cause uncontrolled and rapid decomposition of Ultraform® during processing. Pellets and finished parts must not be allowed to come into contact with strong acids (especially concentrated hydrochloric acid) since they cause Ultraform® to decompose.

General	
Material Status	Commercial: Active
Availability	• Europe
Features	General Purpose
Uses	General Purpose
Forms	Granules
Processing Method	Injection Molding
Resin ID (ISO 1043)	• POM

hysical	Nominal Value Unit	Test Method
Density	1.40 g/cm³	ISO 1183
Melt Volume-Flow Rate (MVR) (190°C/2.16 kg)	7.50 cm³/10min	ISO 1133
Water Absorption		ISO 62
24 hr, 23°C	0.80 %	
Equilibrium, 23°C, 50% RH	0.20 %	
lechanical	Nominal Value Unit	Test Method
Tensile Modulus	2450 MPa	ISO 527-2
Tensile Stress (Yield)	63.0 MPa	ISO 527-2/50
Tensile Strain (Yield)	13 %	ISO 527-2/50
Nominal Tensile Strain at Break	33 %	ISO 527-2/50
Tensile Creep Modulus ² (1000 hr)	1300 MPa	ISO 899-1
mpact	Nominal Value Unit	Test Method
Charpy Notched Impact Strength		ISO 179/1eA
-30°C	5.5 kJ/m²	
23°C	6.5 kJ/m²	
Charpy Unnotched Impact Strength		ISO 179/1eU
-30°C	190 kJ/m²	
23°C	260 kJ/m²	
lardness	Nominal Value Unit	Test Method
Ball Indentation Hardness (H 358/30)	130 MPa	ISO 2039-1
hermal	Nominal Value Unit	Test Method
Heat Deflection Temperature		ISO 75-2/A
1.8 MPa, Unannealed	100 °C	
Melting Temperature	167 °C	ISO 11357-3
CLTE - Flow (23 to 55°C)	0.00011 cm/cm/°C	ISO 11359-2
Maximum Dynamic Service Temperature	100 °C	

Dongguan Yi-Ming Plastic Chemical Co., Ltd.

如需要更多物性资料请查阅 www.kedisujiao.com

备注:以上原料物性数据由厂家发布,我公司仅提供参考!数据如有变动,请联系原料生产厂家获知。我公司不承担任何法律责任!

Tuesday, December 15, 2009

Ultraform® N2320 0035 Acetal (POM) Copolymer BASF Corporation

Electrical	Nominal Value Unit	Test Method
Surface Resistivity	1.0E+13 ohms	IEC 60093
Volume Resistivity	1.0E+15 ohm·cm	IEC 60093
Relative Permittivity (1 MHz)	3.80	IEC 60250
Dissipation Factor (1 MHz)	0.0050	IEC 60250
Comparative Tracking Index (Solution A)	600 V	IEC 60112
Flammability	Nominal Value Unit	Test Method
Flame Rating - UL (1.60 mm)	НВ	UL 94

Injection	Nominal Value Unit
Processing (Melt) Temp	190 to 230 °C
Mold Temperature	60.0 to 100 °C

Notes

Dongguan Yi-Ming Plastic Chemical Co., Ltd.

如需要更多物性资料请查阅 www.kedisujiao.com

备注:以上原料物性数据由厂家发布,我公司仅提供参考!数据如有变动,请联系原料生产厂家获知。我公司不承担任何法律责任!

¹ Typical properties: these are not to be construed as specifications.

² Strain <= 0.5%, 23°C